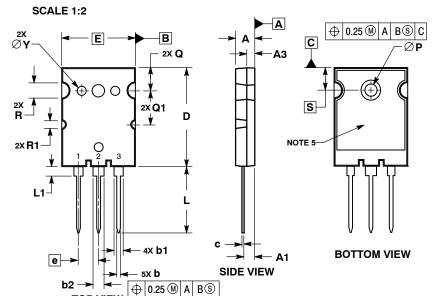
TOP VIEW



TO-264, 3-LEAD CASE 340AJ **ISSUE O**

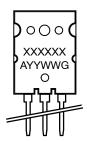
DATE 04 FEB 2013



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ASME
- CONTROLLING DIMENSION: MILLIMETERS.
 DIMENSION 6 APPLIES BETWEEN 2.50 AND 3.81
- FROM THE LEAD TIP.
 DIMENSION S APPLIES TO THE MOUNTING HOLE (ØP). DIMENSION Q APPLIES TO THE NOTCHES (2X R).
- THERMAL PAD SIZE AND SHAPE MAY VARY WITH-IN THE AREA DEFINED BY DIMENSIONS D AND E.

	MILLIMETERS		
DIM	MIN	MAX	
Α	4.80	5.20	
A1	2.50	3.10	
А3	2.00 REF		
b		1.25	
b1	2.50 REF		
b2	3.00 REF		
С	0.50	0.85	
D	25.60	26.40	
Е	19.80	20.20	
е	5.45 BSC		
L	16.80	18.20	
L1	2.30	2.70	
P	3.10	3.50	
Q	5.80	6.20	
Q1	8.80	9.20	
R	4.00 REF		
R1	2.00 REF		
S	9.00 BSC		
Υ	1.80 REF		

GENERIC MARKING DIAGRAM*



XXXXXX = Specific Device Code

= Assembly Location Α

YY = Year ww = Work Week = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

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